



Docket No.: ASMMC.036AUS

2813
Customer No.: 20,995 JFW

AMENDMENT / RESPONSE TRANSMITTAL

Applicant : Sophie et al.
App. No. : 09/975,466
Filed : October 9, 2001
For : IN SITU REDUCTION OF
COPPER OXIDE PRIOR TO
SILICON CARBIDE
DEPOSITION
Examiner : Kielin
Art Unit : 2813

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

June 30, 2004

(Date)

Andrew N. Merickel, Reg. No. 53,317

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing in the above-identified application are the following enclosures:

- (X) Response to Office Action in 4 pages and 3 pages of attachments.
- (X) Return prepaid postcard.
- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

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ASMMC.036AUS

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

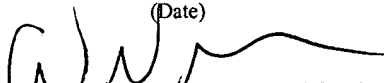
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RESPONSE TO OFFICE ACTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

This paper is response to the Office Action mailed on March 31, 2004. Applicants respectfully request consideration of the following remarks.

Remarks/Arguments begin on page 2 of this paper.